

BAV70QA-Q

Dual common cathode high-speed switching diode

6 March 2025

Product data sheet

1. General description

Dual common cathode high-speed switching diode encapsulated in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- High switching speed: $t_{rr} \leq 4$ ns
- Low leakage current: $I_R \leq 0.5$ μ A
- Reverse voltage $V_R \leq 100$ V
- Low capacitance $C_d \leq 1.5$ pF
- Ultra small SMD plastic package
- Low package height of 0.37 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- High-speed switching
- General-purpose switching

4. Quick reference data

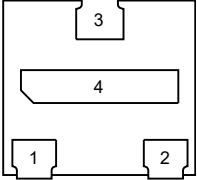
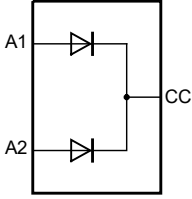
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
I_F	forward current	single diode loaded; $T_{amb} = 25$ °C	[1]	-	-	300	mA
V_R	reverse voltage	$T_j = 25$ °C		-	-	100	V
I_R	reverse current	$V_R = 80$ V; $T_j = 25$ °C		-	-	0.5	μ A
t_{rr}	reverse recovery time	$I_F = 10$ mA; $I_R = 10$ mA; $I_{R(meas)} = 1$ mA; $R_L = 100$ Ω ; $T_{amb} = 25$ °C		-	-	4	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode (diode 1)	 Transparent top view DFN1010D-3 (SOT1215)	 aaa-021931
2	A2	anode (diode 2)		
3	CC	common cathode		
4	CC	common cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAV70QA-Q	DFN1010D-3	plastic, leadless thermal enhanced ultra thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.75 mm pitch; 1.1 mm x 1 mm x 0.37 mm body	SOT1215

7. Marking

Table 4. Marking codes

Type number	Marking code
BAV70QA-Q	Z 010

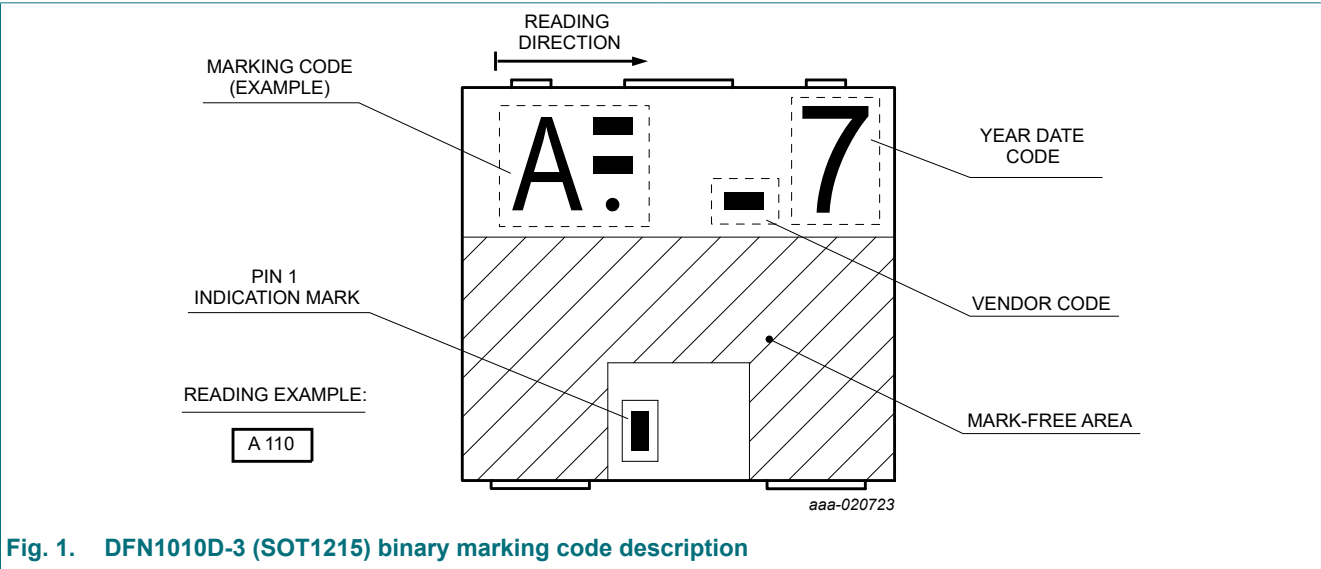


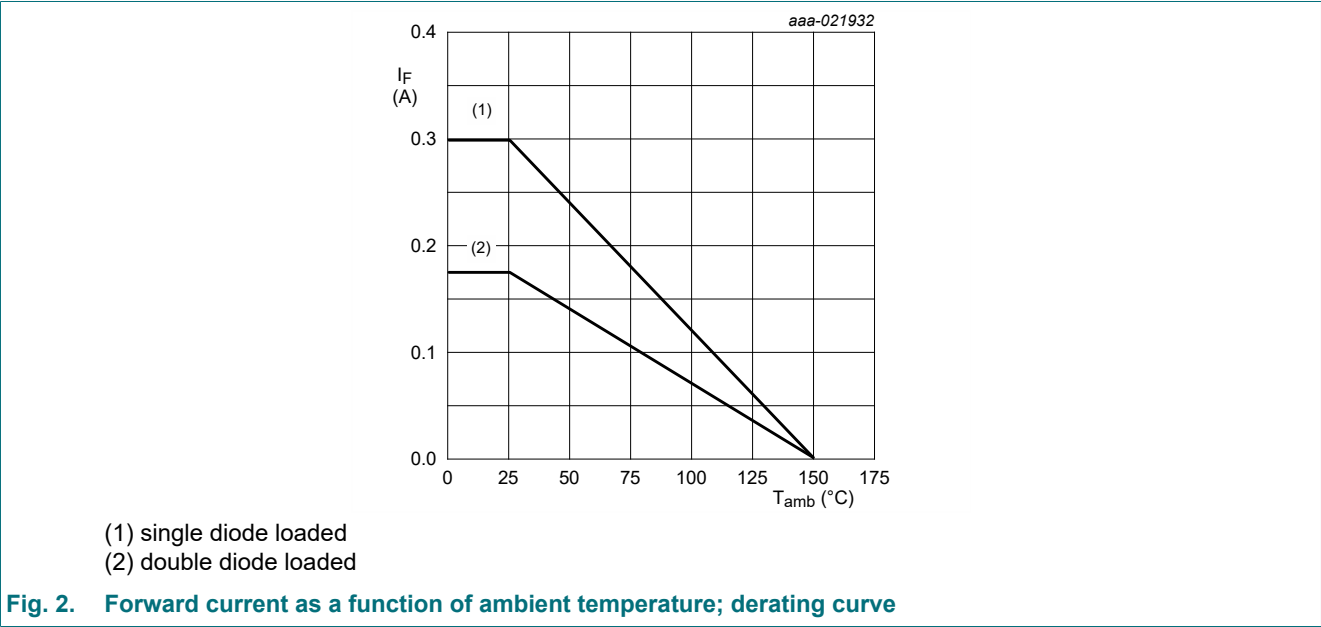
Fig. 1. DFN1010D-3 (SOT1215) binary marking code description

8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
V _R	reverse voltage	T _j = 25 °C		-	100	V
V _{RRM}	repetitive peak reverse voltage			-	100	V
I _F	forward current	single diode loaded; T _{amb} = 25 °C	[1]	-	300	mA
		double diode loaded; T _{amb} = 25 °C	[1]	-	175	mA
I _{FRM}	repetitive peak forward current	t _p ≤ 0.5 ms; δ ≤ 0.25; T _j = 25 °C		-	1	A
I _{FSM}	non-repetitive peak forward current	t _p = 100 μs; square wave; T _{j(init)} = 25 °C		-	4	A
		t _p = 1 ms; square wave; T _{j(init)} = 25 °C		-	1.5	A
		t _p = 1 s; square wave; T _{j(init)} = 25 °C		-	0.5	A
Per device; one diode loaded						
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	325	mW
			[2]	-	540	mW
T _j	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².



9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	385	K/W
			[2]	-	-	230	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	50	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [3] Soldering point of cathode tab.

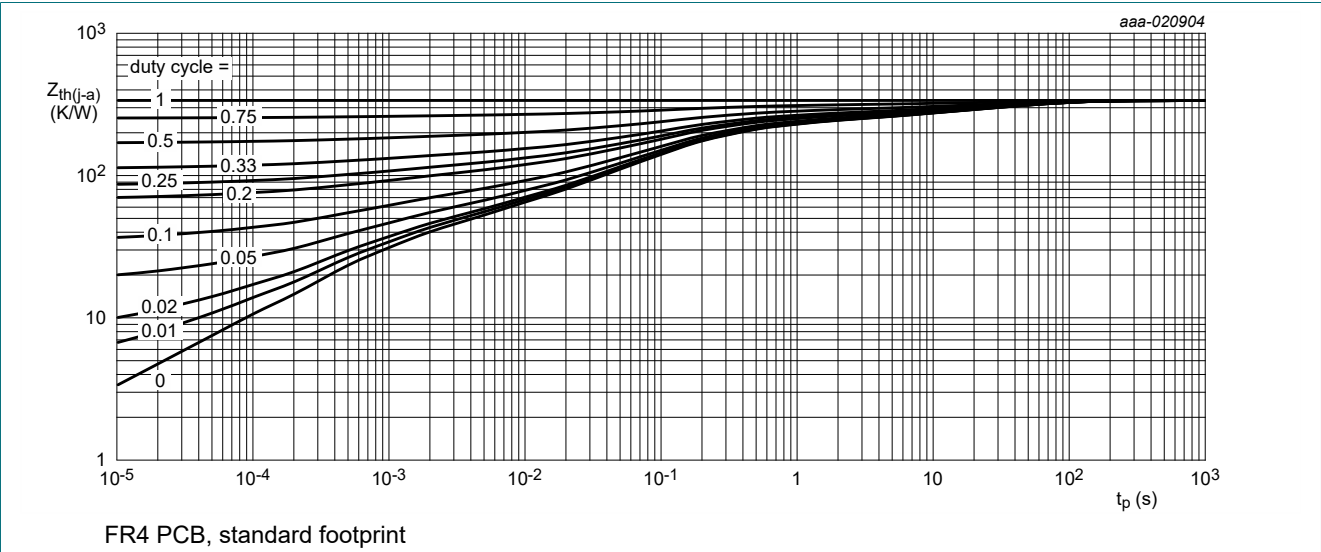


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

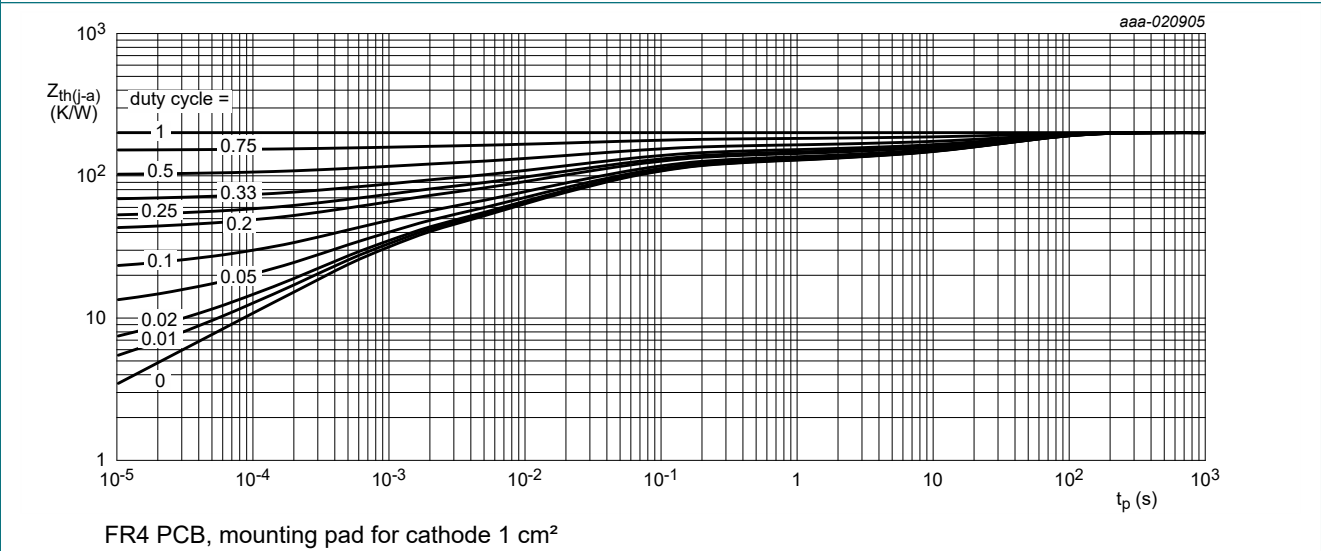
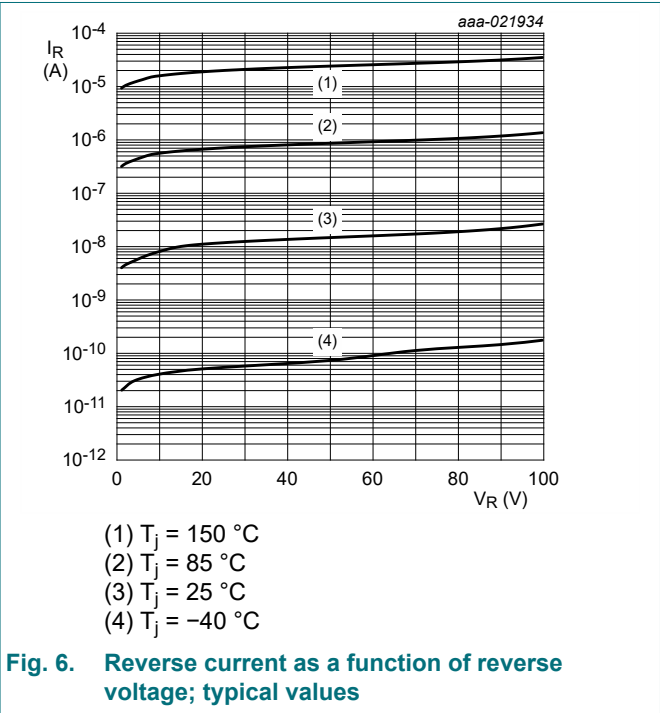
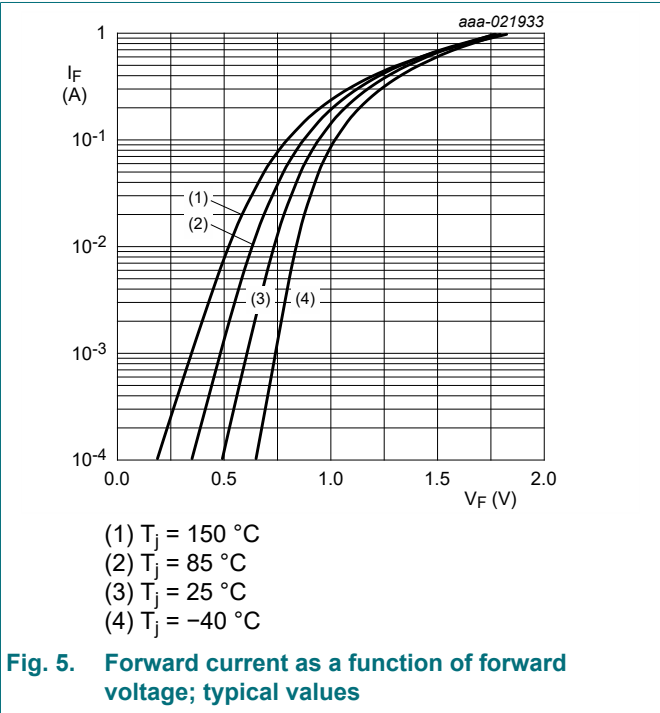


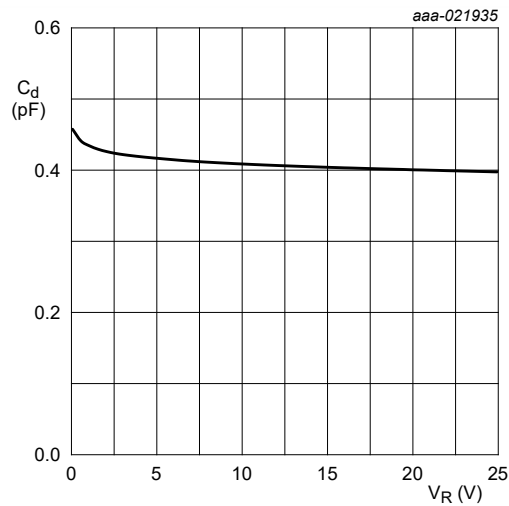
Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

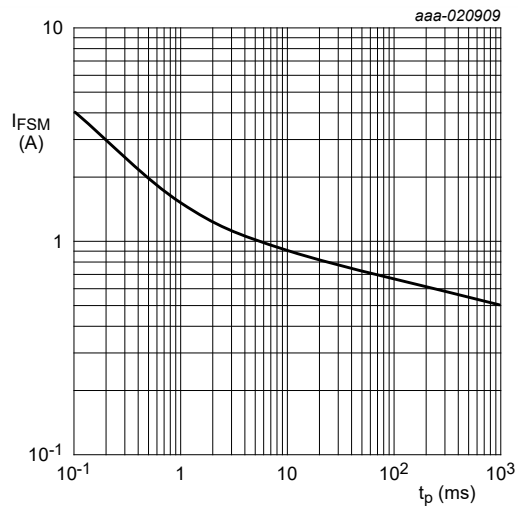
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
V _F	forward voltage	I _F = 1 mA; T _j = 25 °C		-	-	715	mV
		I _F = 10 mA; T _j = 25 °C		-	-	855	mV
		I _F = 50 mA; T _j = 25 °C		-	-	1	V
		I _F = 150 mA; T _j = 25 °C		-	-	1.25	V
I _R	reverse current	V _R = 25 V; T _j = 25 °C		-	-	30	nA
		V _R = 80 V; T _j = 25 °C		-	-	0.5	µA
		V _R = 25 V; T _j = 150 °C		-	-	30	µA
		V _R = 80 V; T _j = 150 °C		-	-	100	µA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz; T _j = 25 °C		-	-	1.5	pF
t _{rr}	reverse recovery time	I _F = 10 mA; I _R = 10 mA; I _{R(meas)} = 1 mA; R _L = 100 Ω; T _{amb} = 25 °C		-	-	4	ns
V _{FRM}	peak forward recovery voltage	I _F = 10 mA; t _r = 20 ns; T _{amb} = 25 °C		-	-	1.75	V





$f = 1\text{MHz}$; $T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$

Fig. 7. Diode capacitance as a function of reverse voltage; typical values



Based on square wave currents.
 $T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$

Fig. 8. Non-repetitive forward current as a function of pulse duration; maximum values

11. Test information

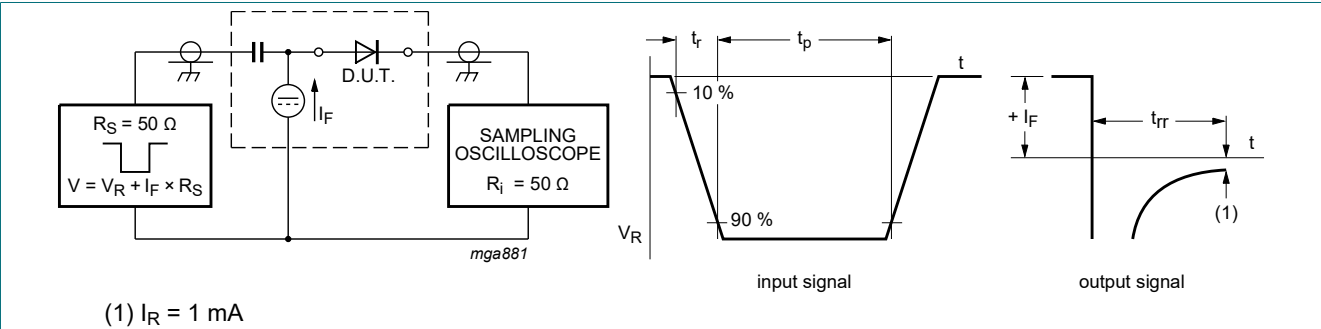


Fig. 9. Reverse recovery time test circuit and waveforms

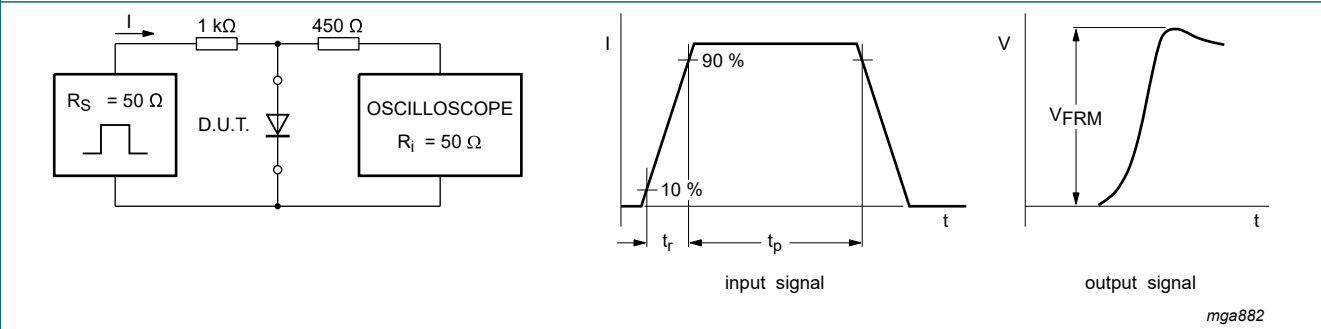


Fig. 10. Forward recovery voltage test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

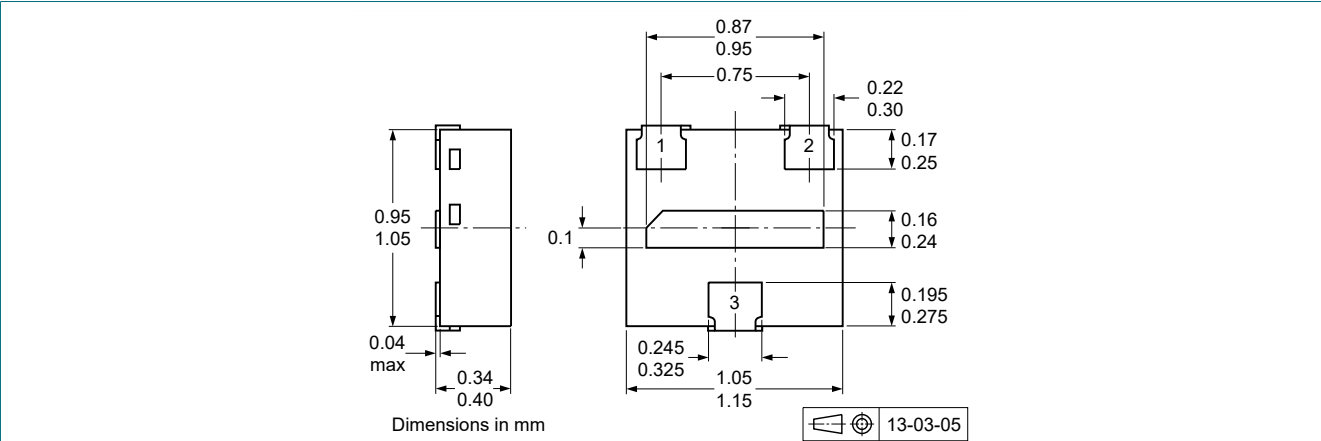
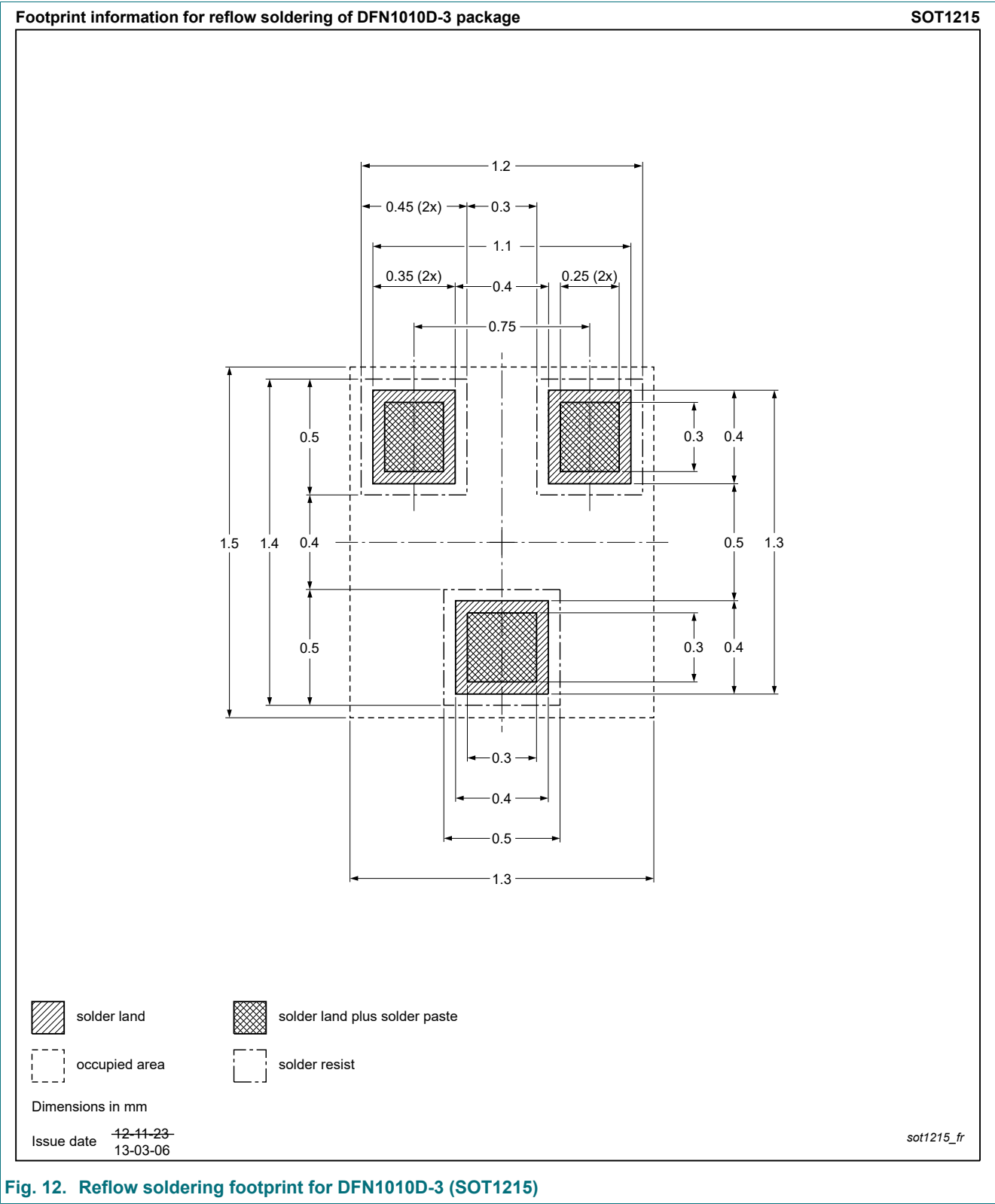


Fig. 11. Package outline DFN1010D-3 (SOT1215)

13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAV70QA-Q v.1	20250306	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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